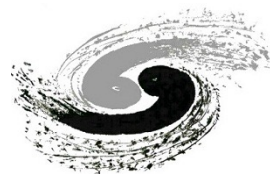


束流测试线上的粒子探测器研究

史欣



2022年12月28日

质子试验束探测器讨论会

内容概要

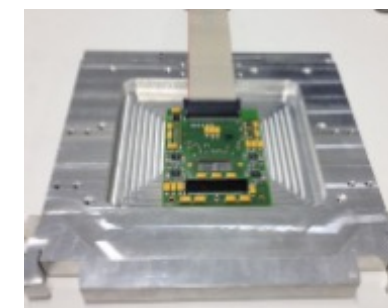
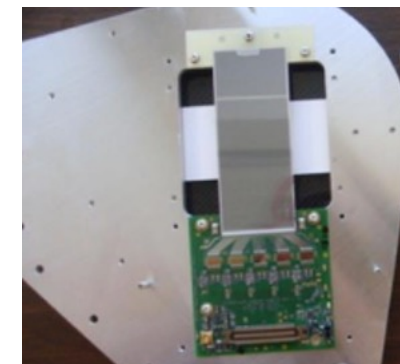
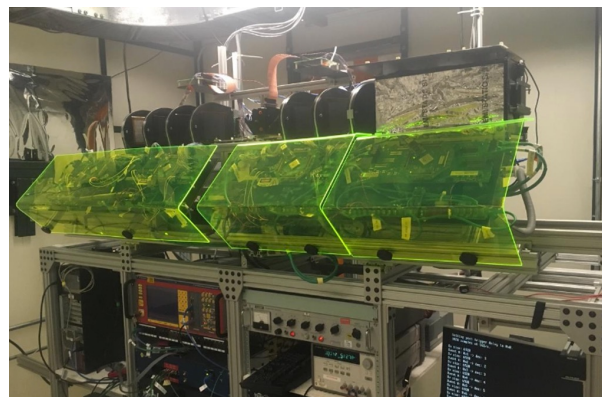
- 探测器研究的种类
 - 位置测量
 - 时间测量
 - 能量测量
 - 辐照测量
- 总结与展望

<https://indico.cern.ch/event/1058977/>

10th Beam Telescopes and Test Beams Workshop

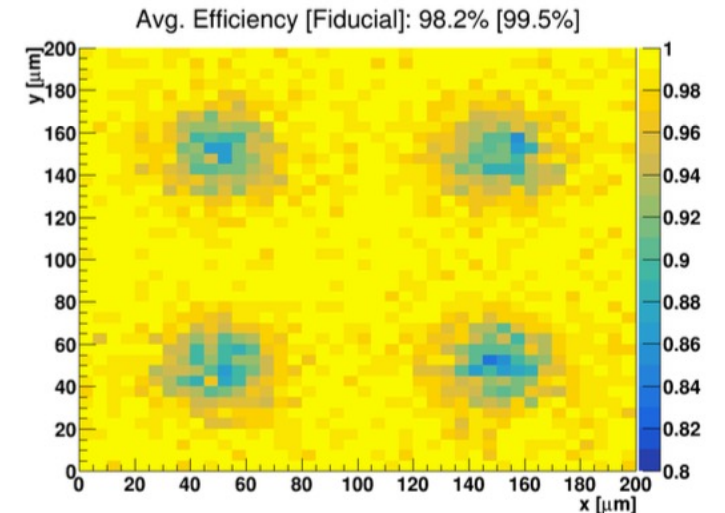
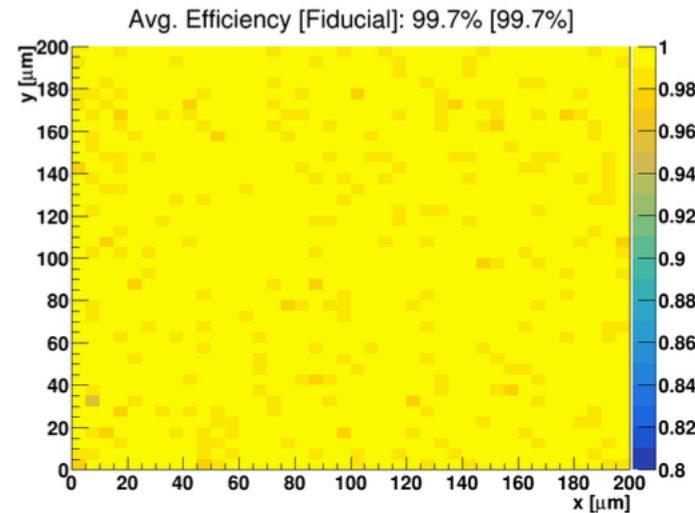
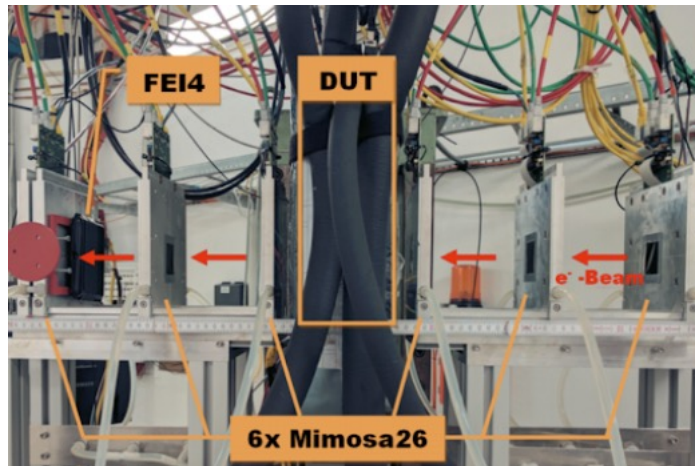
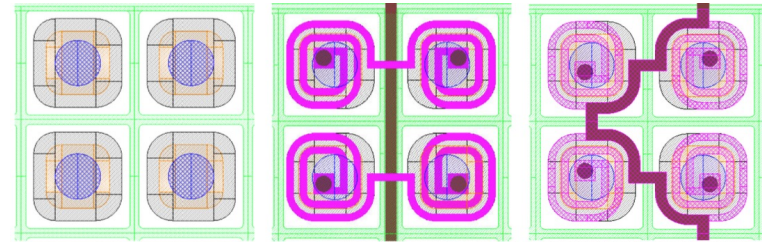
探测器位置分辨研究

- 束流望远镜, 用于研究硅微条、硅像素型探测器
- FNAL
 - 空间分辨 $5\ \mu\text{m}$
 - 硅微条探测器覆盖 $3.8\ \text{cm} \times 3.8\ \text{cm}$
 - 未来升级为像素型探测器
- DESY
 - 6层像素型传感器 (MIMOSA26)
 - 空间分辨率 $\sim 2\ \mu\text{m}$
 - 传感器 $2\ \text{cm} \times 1\ \text{cm}$, 厚度 $50\ \mu\text{m}$
 - 像素尺寸: $18.4\ \mu\text{m} \times 18.4\ \mu\text{m}$
 - DAQ: NI, TLU, EUDAQ



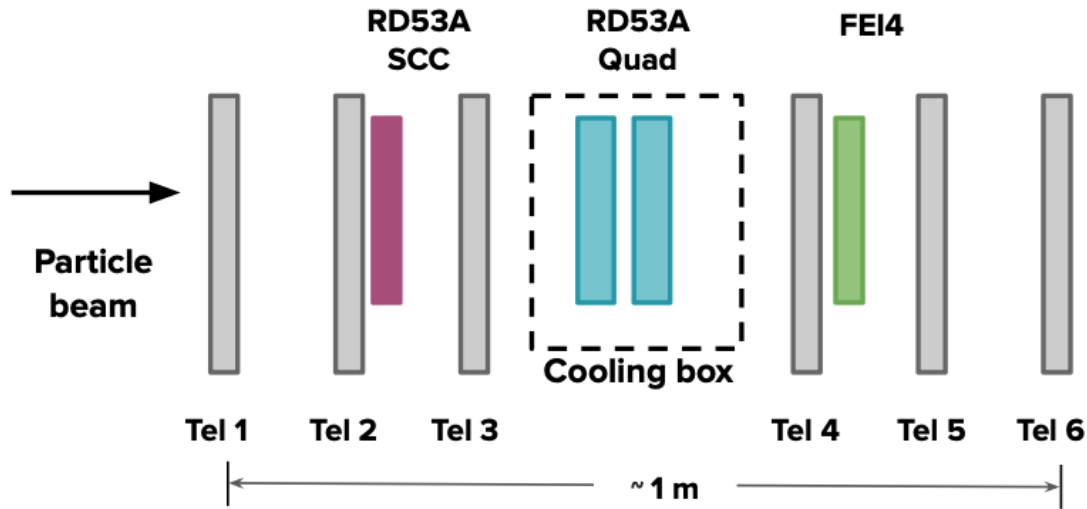
位置分辨研究 – ATLAS ITk RD53A

- RD53A bump-bonded to 150 μm n-in-p planar sensor, 50x50 μm^2
- Different punch through bias (PTB)
- Irradiated $3.4 \times 10^{15} n_{\text{eq}}/\text{cm}^2$



- Modules with and without PTB achieve global efficiency above 97%

位置分辨研究 – ATLAS ITk pixel quad module



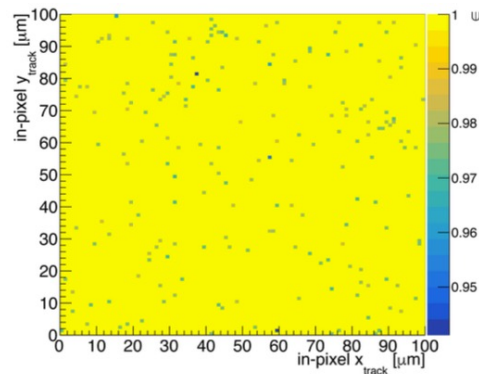
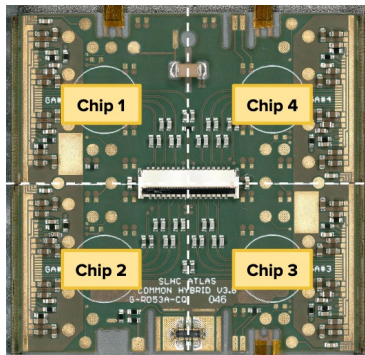
Beam telescope

RD53A single-chip card (SCC) as a timing reference

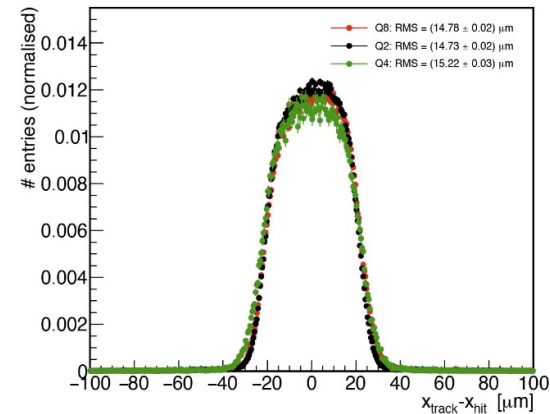
FEI4 single-chip card

RD53A quad modules with n-in-p planar sensors of 150 μm thickness and 50x50 μm^2 pixel size:

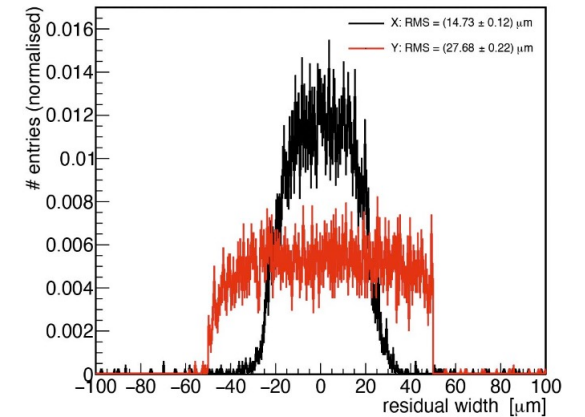
- non-irradiated Hamamatsu (HPK) Q8
- non-irradiated Micron Q2
 - PT biasing structure
- irradiated HPK Q4
 - Fluence: $\phi_{\text{eq}} = 5 \times 10^{15} \text{ n}_{\text{eq}} \text{ cm}^{-2}$



50x50 μm^2 pixels: X dimension



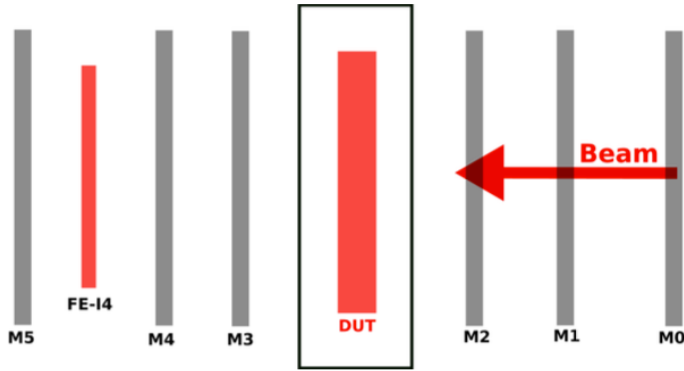
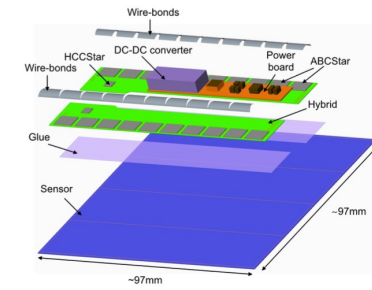
Q8: inter-chip region



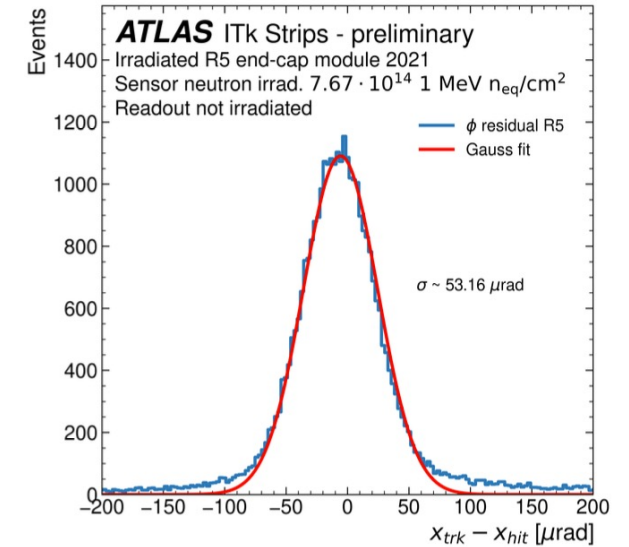
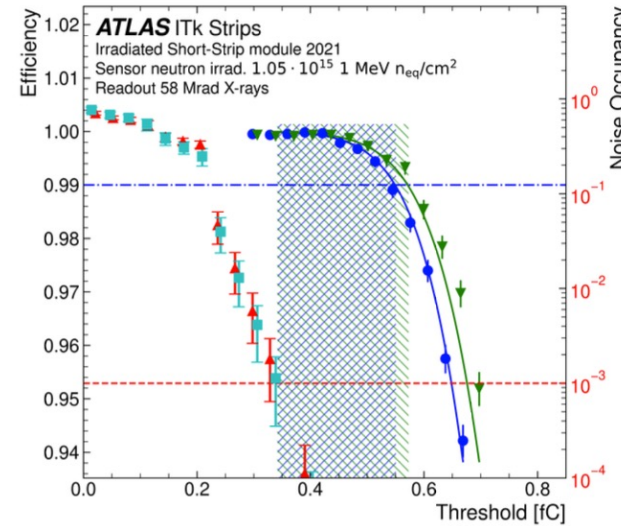
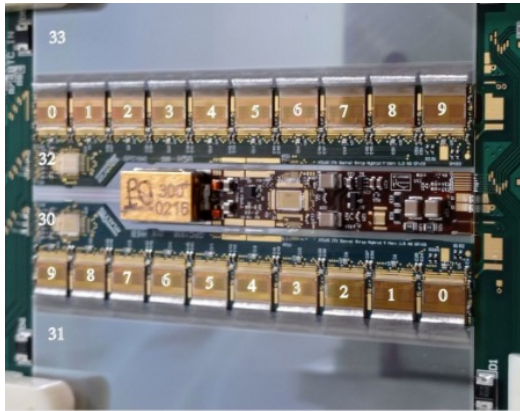
- Hit efficiency $> 97\%$ for irradiated modules

$$\sigma_{\text{int}} (50 \mu\text{m}, 100 \mu\text{m}) = 14.43 \mu\text{m}, 28.87 \mu\text{m}$$

位置分辨研究 – ATLAS ITk strip



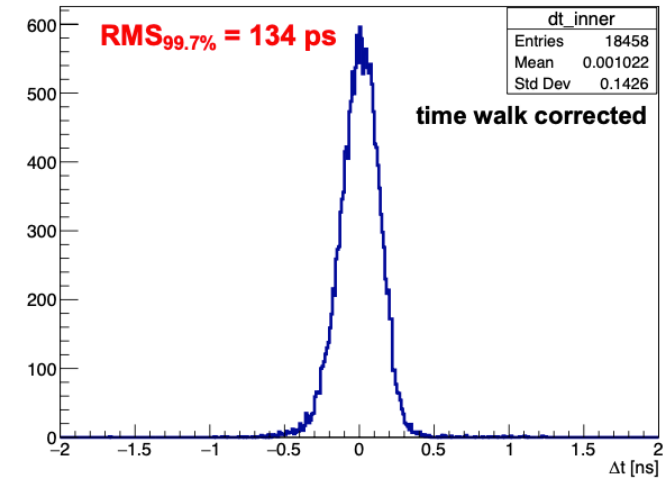
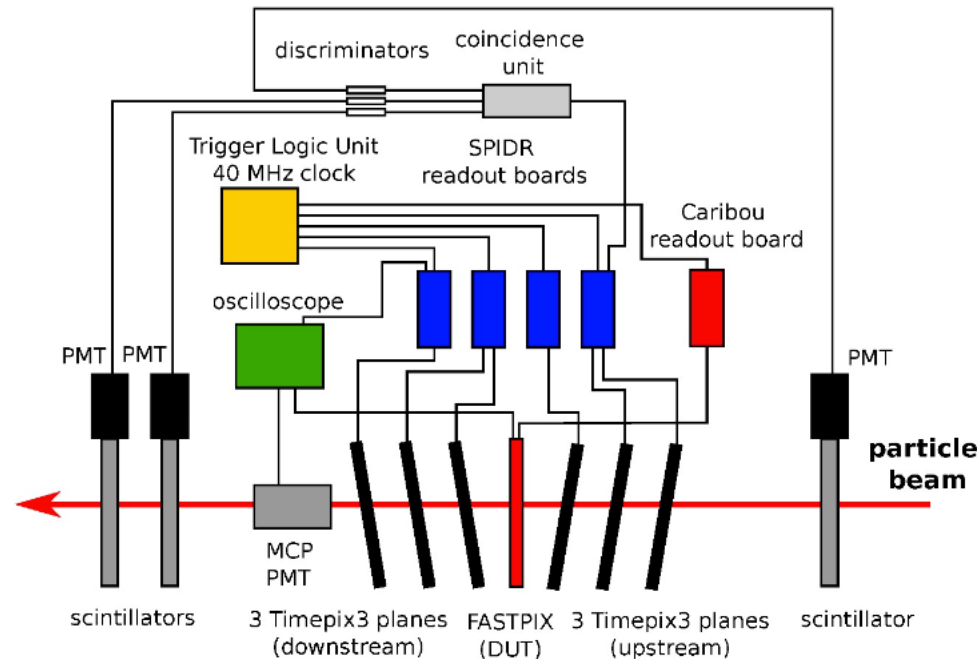
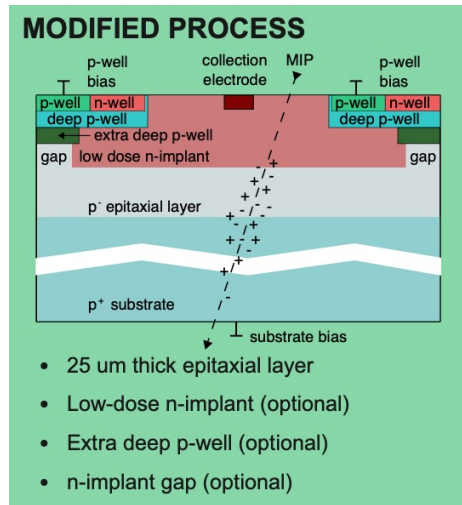
- Six Mimosa26 planes and an additional FE-I4 timing plane (with USBPix read-out).
- EUDAQ2 used for control and read-out of the telescope and the DUT.
- Tracking resolution of 5–10 μm .
- DUT placed in a cold box and operated at -500V bias voltage.



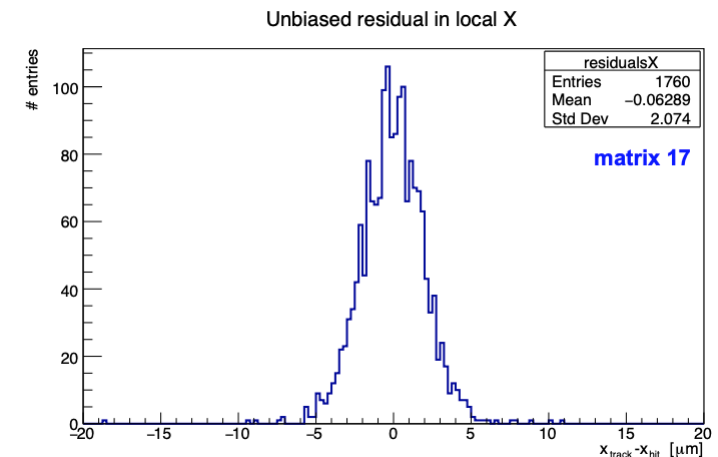
- Short-Strip modules: S/N 16.9 (>10) efficiency > 99% noise occupancy < 0.1%

时间分辨研究 – FASTPIX

- Monolithic pixel sensor 180nm CMOS imaging process

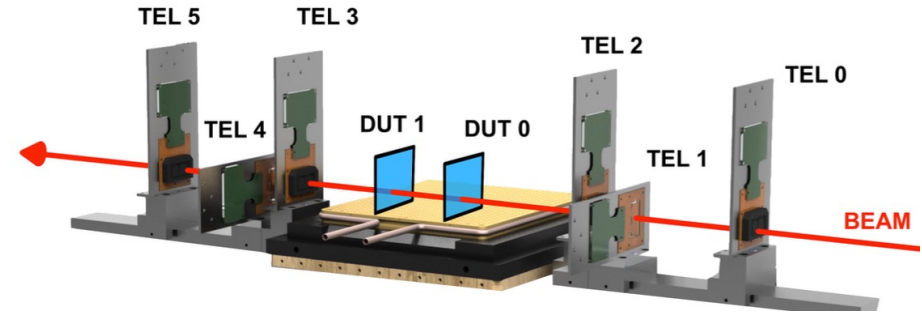


- reaches a timing precision of $O(150\text{ps})$
- spatial resolution $1.0\mu\text{m} - 3.8\mu\text{m}$

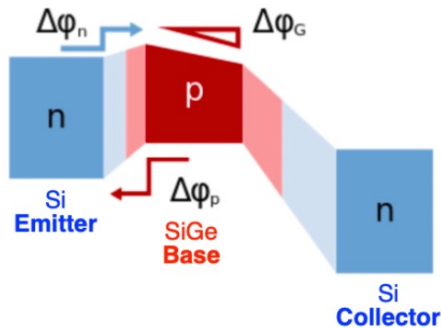


时间分辨研究 – ATTRACT

- Monolithic SiGe BiCMOS pixel sensor



NPN SiGe HBT
(depleted regions in light colors)
from wikipedia



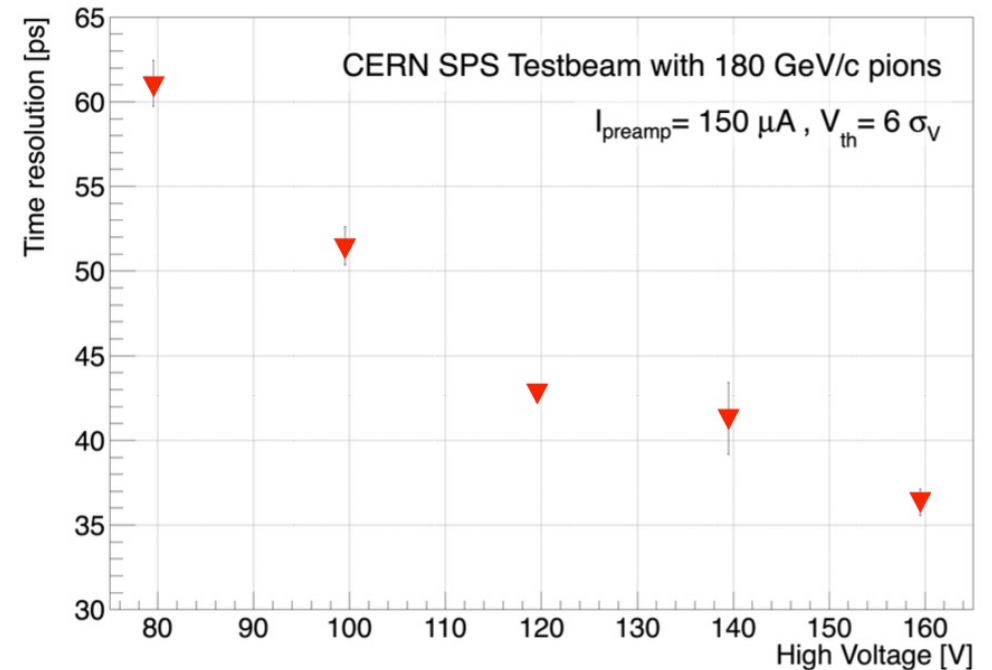
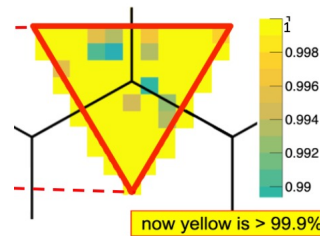
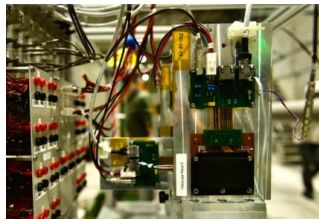
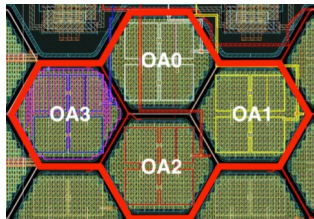
Reduced base resistance R_b

Higher current gain β

Charge transport via drift

Reduced Equivalent Noise Charge (ENC):

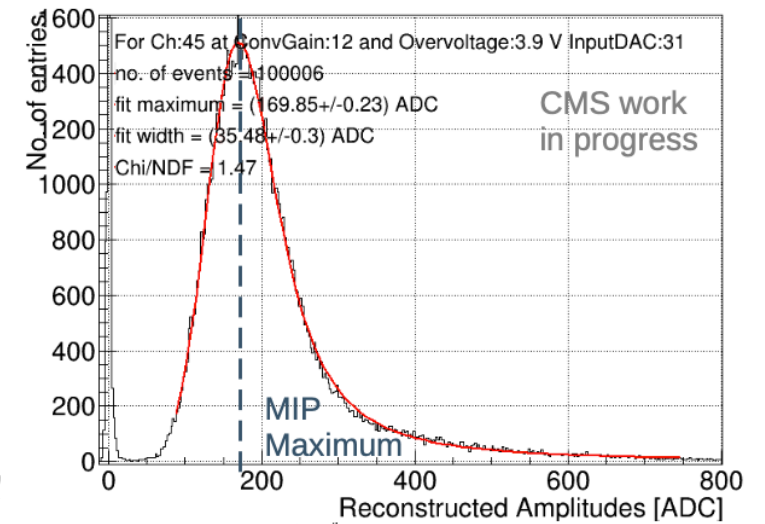
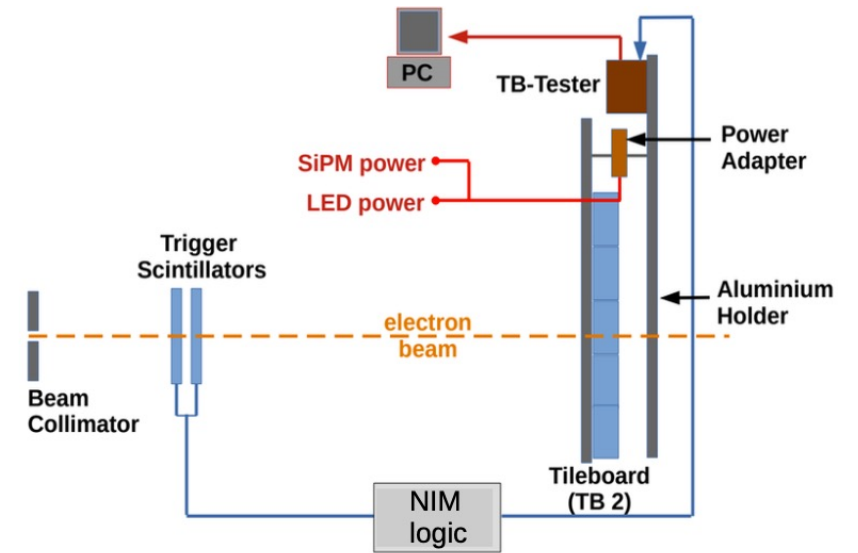
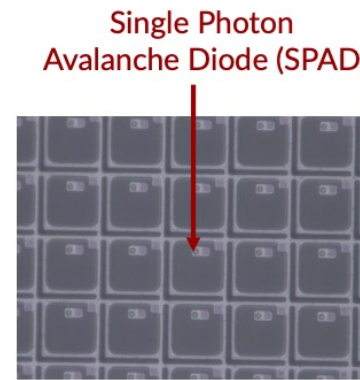
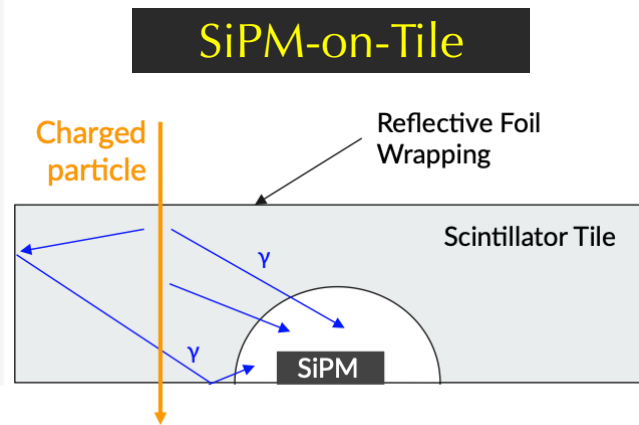
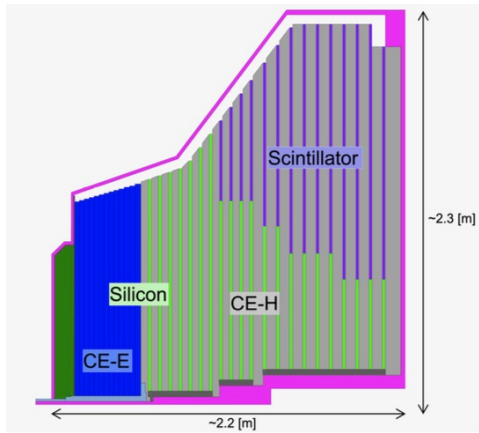
$$ENC_{Series\ Noise} \propto \sqrt{k_1 \frac{C_{tot}^2}{\beta} + k_2 R_b C_{tot}^2}$$



- Power 1.8W /cm², 36ps, efficiency 99.9%

量能器研究 – CMS HGCAL

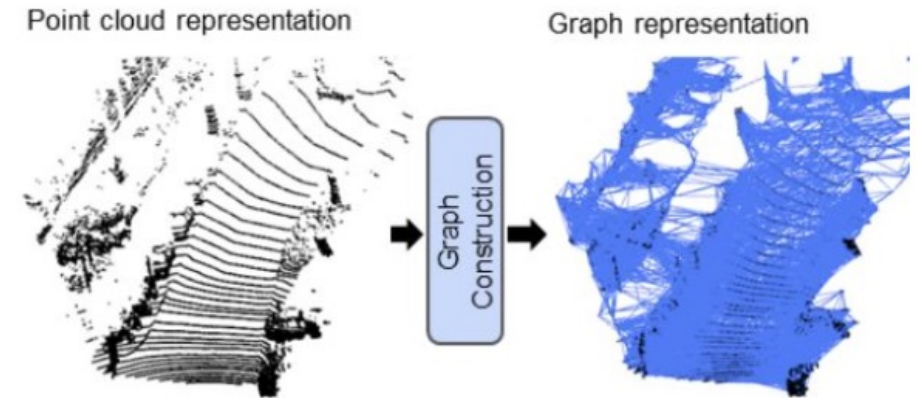
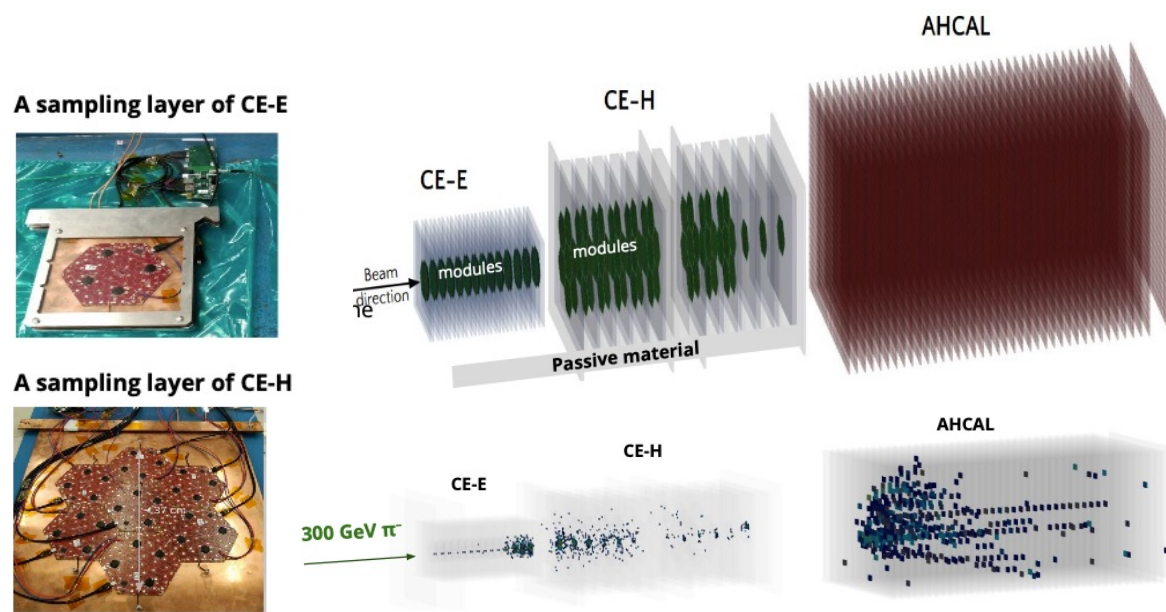
- 5D (imaging) calorimeter using particle flow
 - Silicon and scintillator section



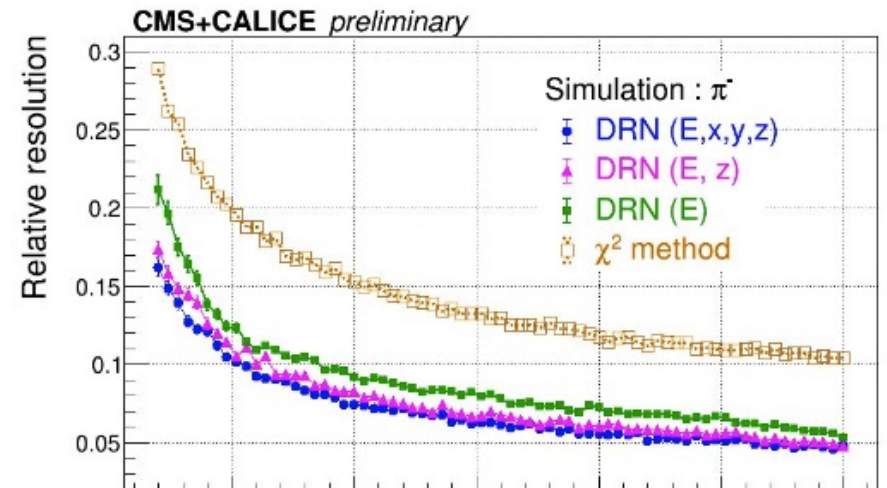
- Measure particle trigger time with ~ 0.8 ns resolution

量能器研究 - 用GNN对 π 进行能量重建

- π - energy reconstruction in HGCAL using Graph Neural Networks (GNNs)

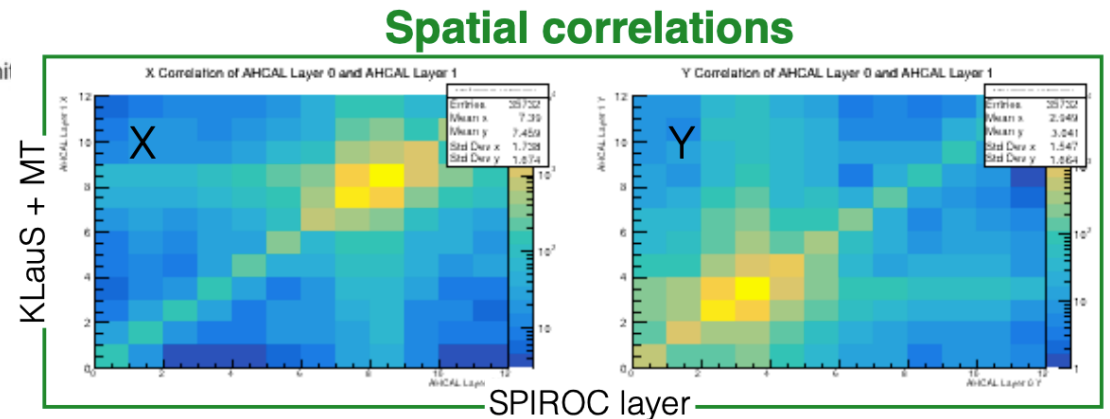
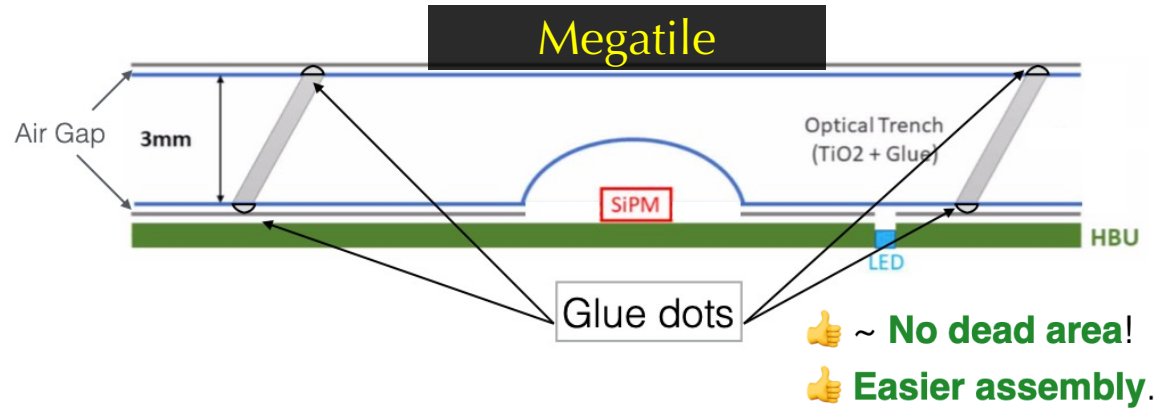
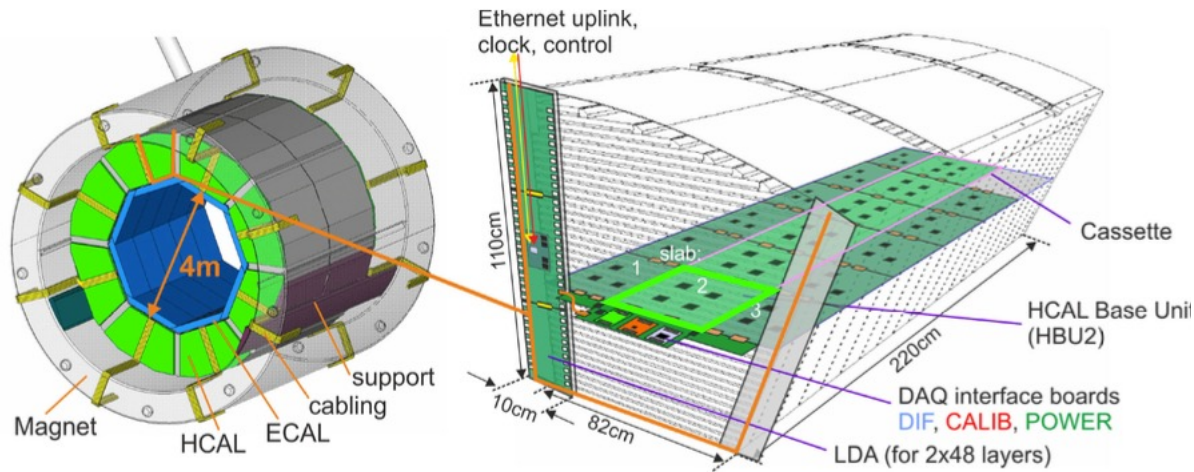


- GNN method substantially improves the energy resolution compared to simple energy reconstruction based on χ^2 method



量能器研究 – CALICE AHCal test beams

- AHCal: Analogue Hadronic Calorimeter
 - Plastic scintillator tiles, SiPM readout
 - Hadronic calorimetry few % resolution



- Good space and time correlations observed.

Irradiation Facility: Why ?

▶ Radiation damage studies on:

- **materials** used around accelerators/experiments
 - structural material, glues, pipes, insulations, thermal materials, ...
- **electronic components**
 - transistors, memories, COTS, ASIC, ...
- **semiconductor** and **calorimetry** devices
 - silicon diodes, detector structures, scintillating crystals ...
 - **equipment sitting in the inner/middle layers of HEP experiments**

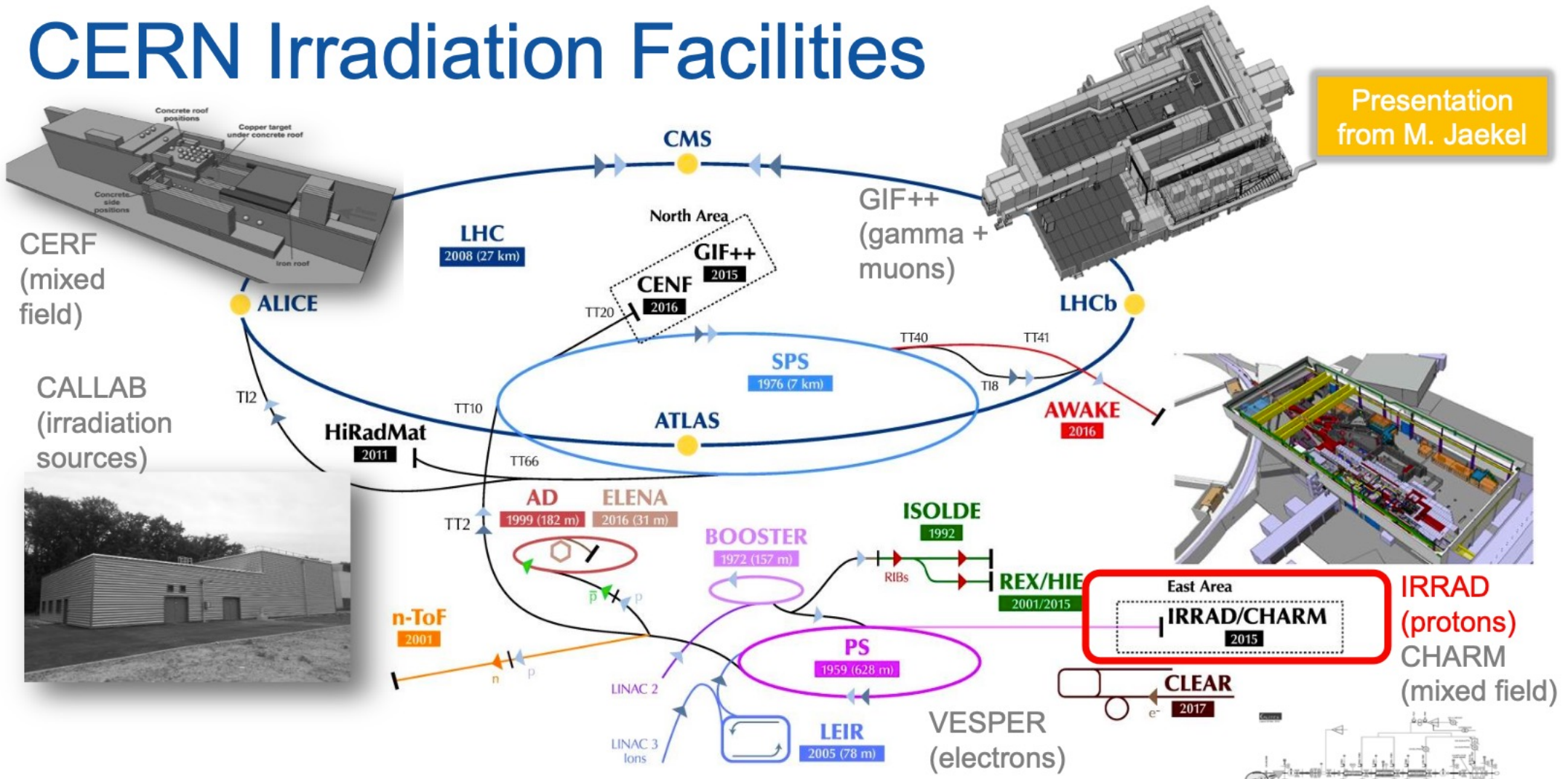
▶ Test and development of prototypes / final assemblies / electronics equipment before installation:

- performance **degradation after long exposure**/ageing (TID, NIEL, ...)
- functional **degradation of electronics** (SEU, latch-up, ...)

▶ Test and calibration of components:

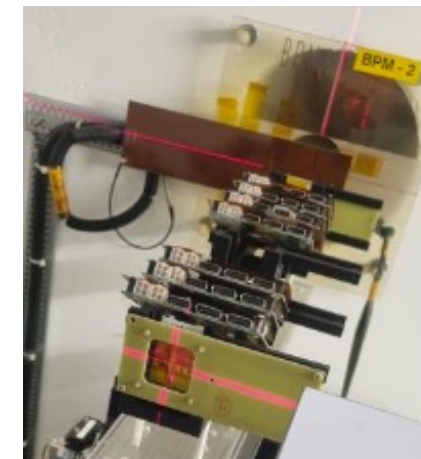
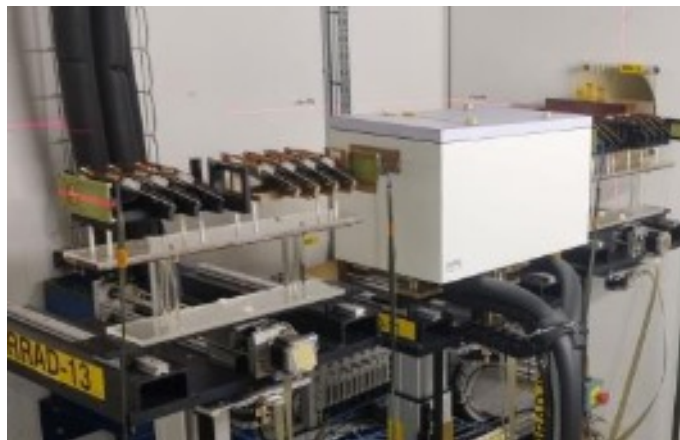
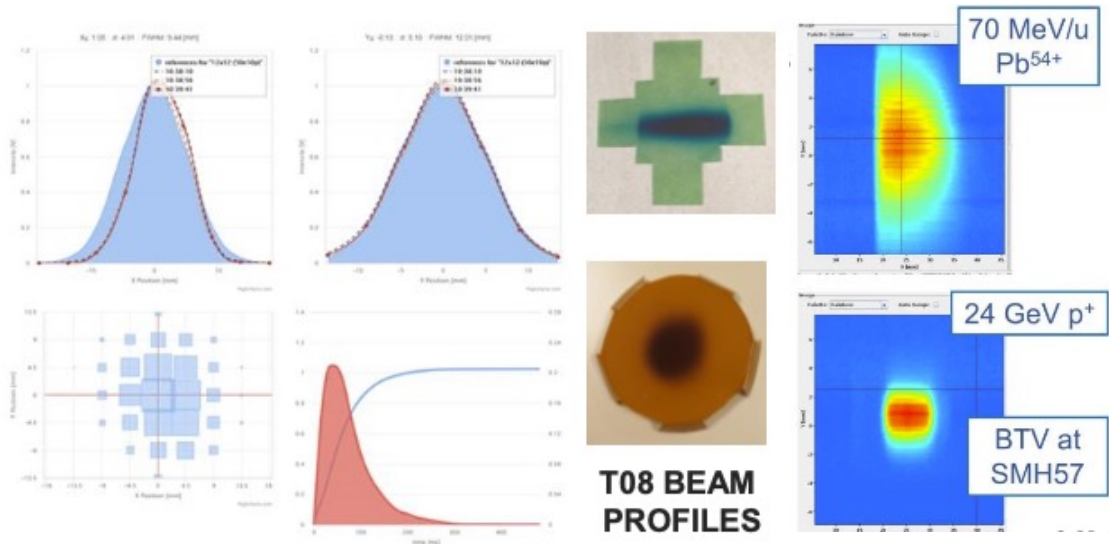
- **dosimeters**, radiation monitoring / measurement devices
- detector performance in presence of high background

CERN Irradiation Facilities



Presentation from M. Jaekel

IRRAD Beam Commissioning and User Run



用户需求响应

- 高能物理实验：
 - 位置精度：3 μm
 - 能量精度： $<2\%$
 - 能量范围：最低至100MeV
 - 单质子计数率：1kHz以上
 - 次级计数率：100Hz以上
- 航天器探测器测试需求：
 - 面积：10 \times 10cm²
 - 计数率：1kHz以下
- 测试环境
 - 温度环境：-40 $^{\circ}\text{C}$ ~ 100 $^{\circ}\text{C}$
 - 磁场环境：~1.5T

总结与展望

- 束流测试线是开展探测器研究的重要基础设施
 - 质子、电子、 π 介子、重离子束流等
- 主要开展的探测器研究包括
 - 位置分辨：微条、像素型
 - 时间分辨：LGAD、3D、CMOS, SiGe BiMOS 等
 - 能量测量：SiPM-on-Tile, 5D, HGCal, AHCAL
 - 辐照研究：材料、电子学、半导体探测器、量能器等
- 未来束流测试平台：综合位置分辨、时间测量、能量测量、辐照等

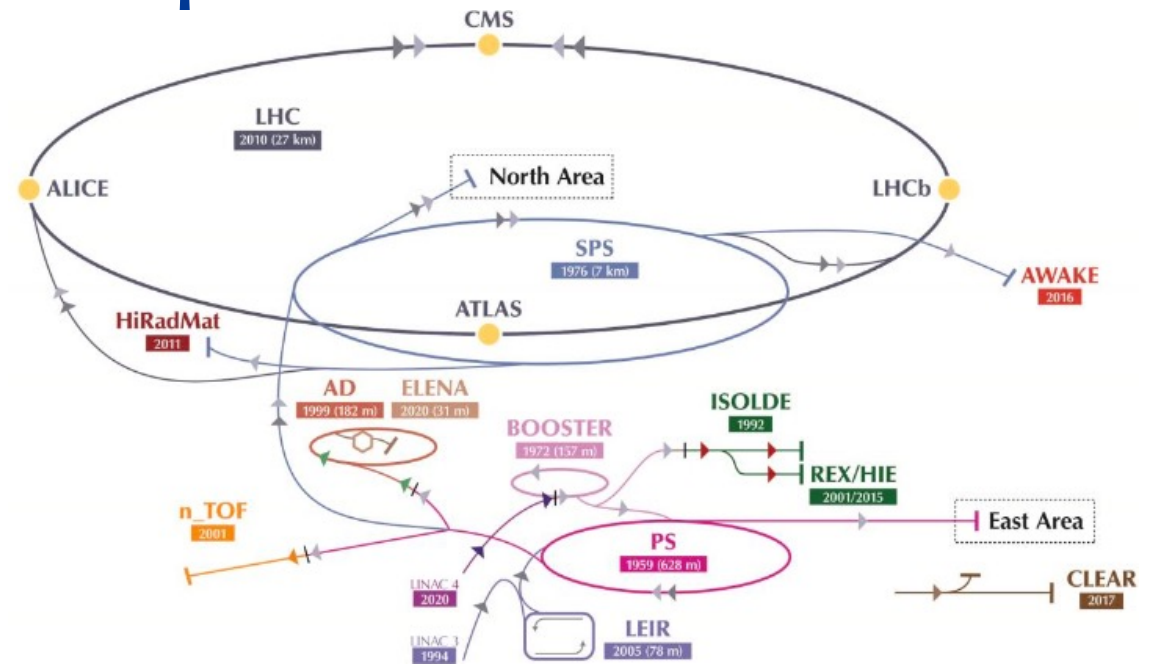
Backup

束流测试线的种类

粒子类型	束流能量	束流强度	供数时间	所属实验
质子	24 GeV			CERN/SPS
质子	400 GeV			CERN/PS
电子	0.45GeV ~ 6.3GeV	10k	99%	DESY
质子	120 GeV	1k~900k	9 m/year	FNAL
质子	1~66 GeV			FNAL
质子	200 MeV			FNAL

CERN has a test beam complex

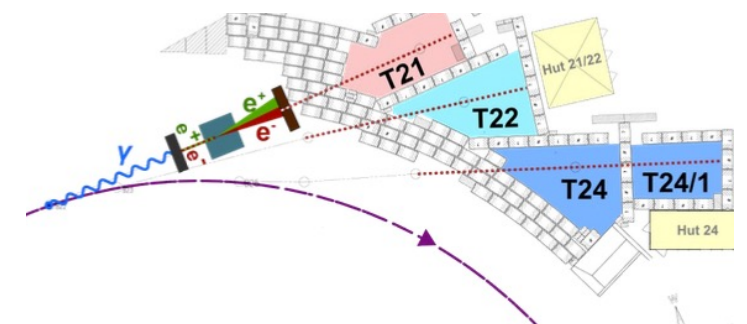
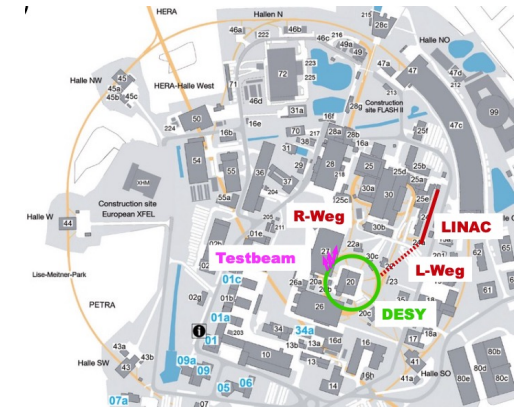
- East Area
 - Momentum : 0.5 GeV/c – 15 GeV/c
- North Area
 - Momentum: 10 GeV/c – 400 GeV/c
- Capable to provide
 - Protons
 - Electrons
 - Hadrons
 - Pure pions
 - Muons
 - Tagged photons
- Diverse instrumentation for various purposes



SPS : protons/ions @ **400 GeV/c/Z**
PS: protons /ions @ **24 GeV/c/Z**

DESY II Test Beam

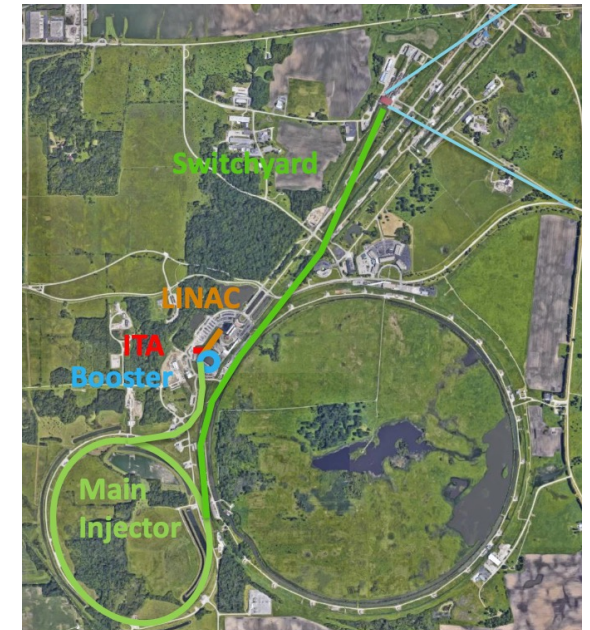
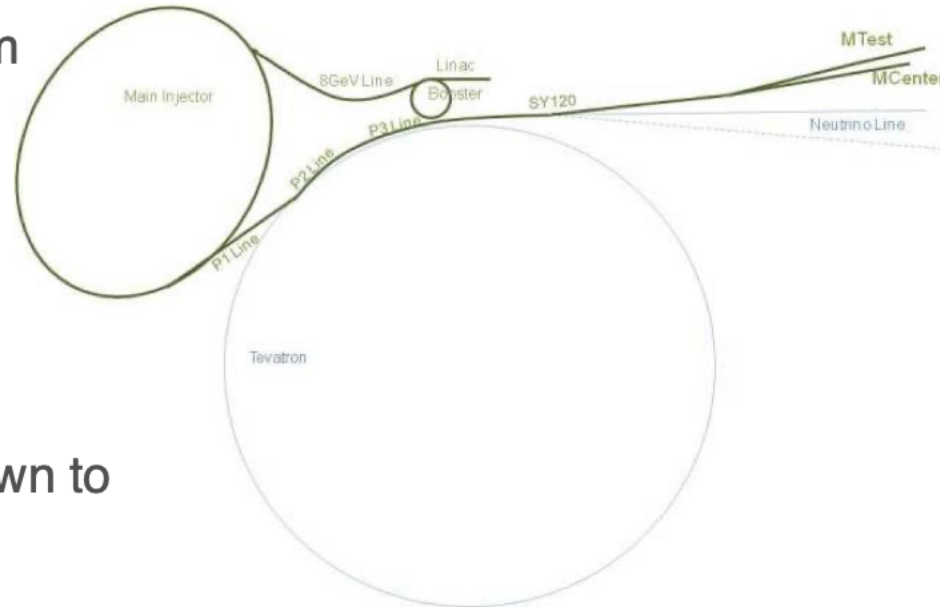
- Facility parasitically fed by DESY II synchrotron (PETRA III injector)
 - 1 bunch per fill
 - 1 MHz circulation frequency
 - Energy ramps sinusoidal @ 12.5 Hz, 0.45 ~ 6.3 GeV
 - Very high availability (~99% uptime)
- Test beam generation
 - 3 primary carbon fiber targets generate bremsstrahlung photons
 - Conversion at secondary target to e^+/e^- up to 6 GeV
 - Energy selected with dipole / collimator



Beamline Details

- 4 second beam spill every 60 seconds, available 24/7
- ~1000 to 900,000 particles per spill
- MTest
 - 120 GeV primary protons
 - 1-66 GeV secondary beam
 - ~2cm spot size
 - 1-4 week runs
- MCenter
 - Secondary beam
 - Two tertiary beamlines down to 200 MeV
 - longer term experiments

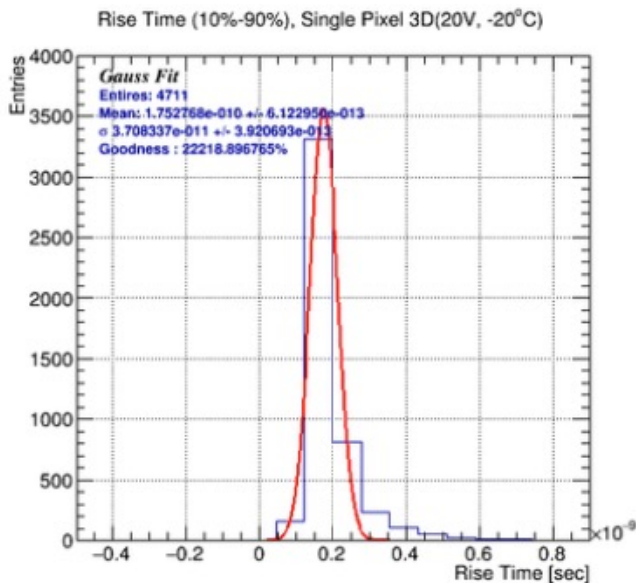
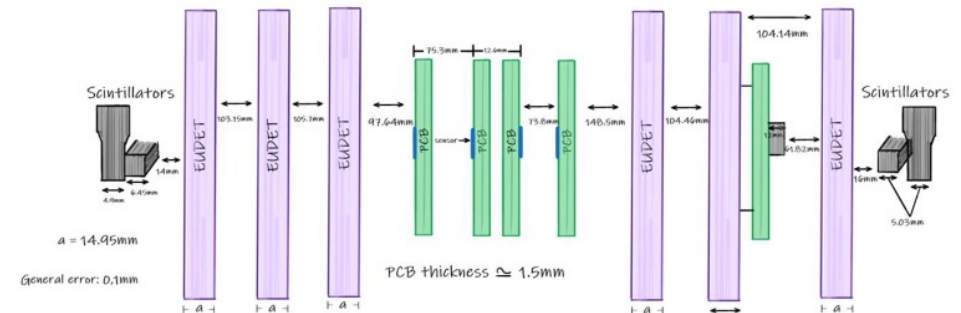
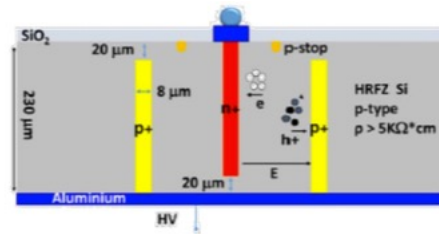
- Fermilab Test Beam Facility (FTBF) – Supports a wide program of research and detector R&D
 - 2 Beamlines (MTest and MCenter) – can provide particles from 120 GeV protons to secondaries of ~200 MeV



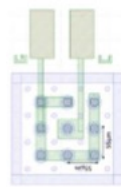
时间分辨研究 - 3D

• 小间距3D传感器

- 解耦电荷产生与漂移体积
- 抗辐照能力强 $\sim 10^{16} n_{eq}/cm^2$
- 漂移距离短, 上升时间快
- 能量沉积扰动小
- 电场不均匀、造价高、单元电容大



ATLAS IBL Type



- ✓ Double sided n-on-p process
- ✓ Pixel Size $55 \times 55 \mu m^2$
- ✓ Active thickness 230 μm
- ✓ High Resistivity ($> 2 k\Omega m \times cm$) Fz silicon

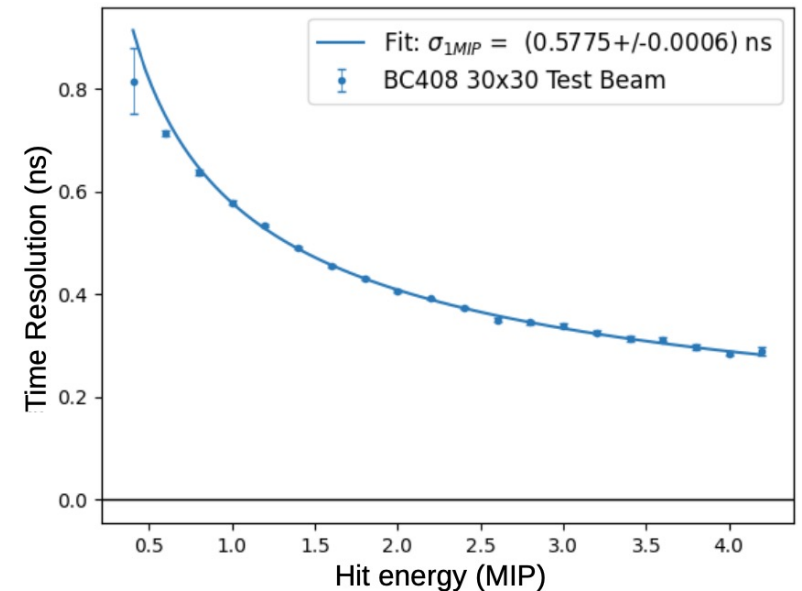
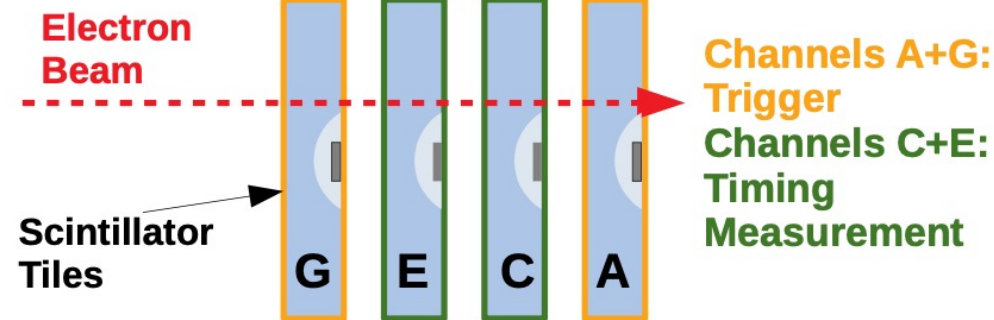
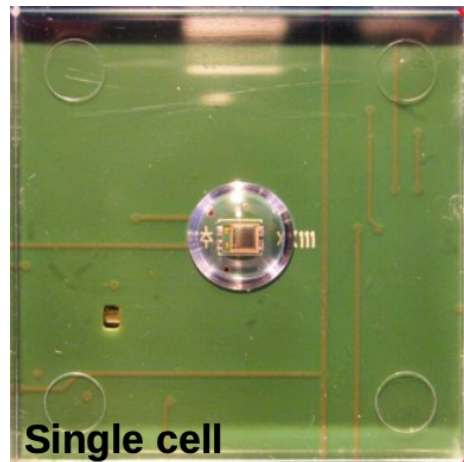
- **Extremely fast rising edge (< 180 psec)**
- **Linear stable behavior with CFD, good SNR control**

$$\sigma_{tot}^2 = \underbrace{\sigma_{timewalk}^2}_{\sigma_{Dist.} + \sigma_{Landau}} + \underbrace{\sigma_{jitter}^2}_{\left(\frac{t_{rise}}{S/N}\right)^2} + \underbrace{\sigma_{conversion}^2}_{\left(\frac{TDC_{bin}}{\sqrt{12}}\right)^2} + \underbrace{\sigma_{Clock}^2}_{\text{Fixed Term } \sim 5-7 \text{ psec}}$$

$$(\sigma_{Dut})_{CFD_{ij}} = \sqrt{(\sigma_{Tot})_{CFD_{ij}}^2 - (\sigma_{Ref})_{CFD_i}^2}$$

量能器研究 – CALICE SiPM-on-Tile

- Scintillator telescope with two coincidence triggers (Ch A+G)
- Two additional scintillator tiles (Ch C+E) to determine time resolution

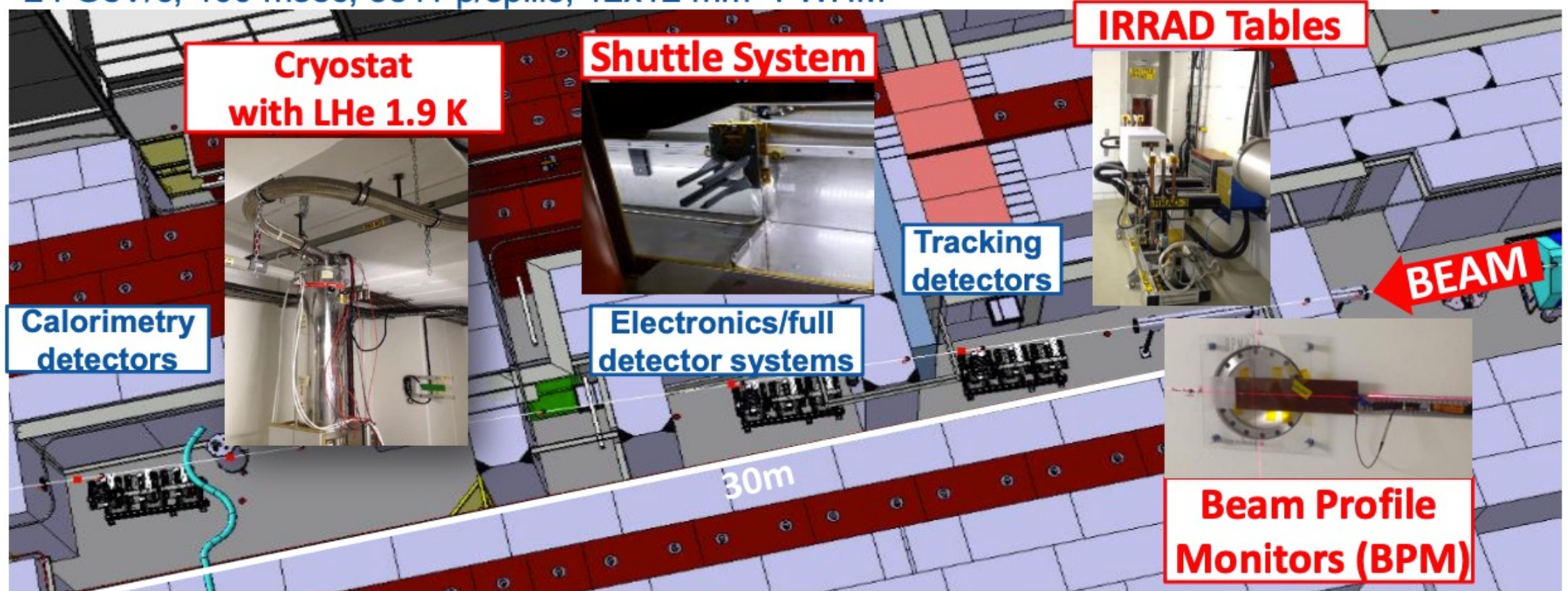


- Tile size 20x20 with time resolution $\sim 380\text{ps}$

CERN Proton Irradiation Facility (IRRAD)

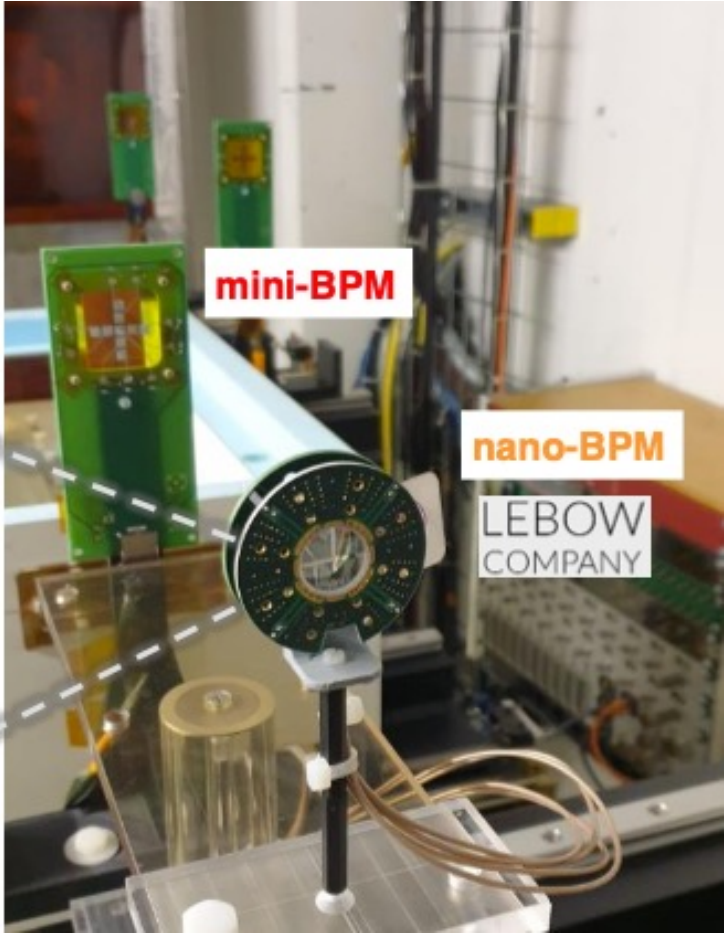
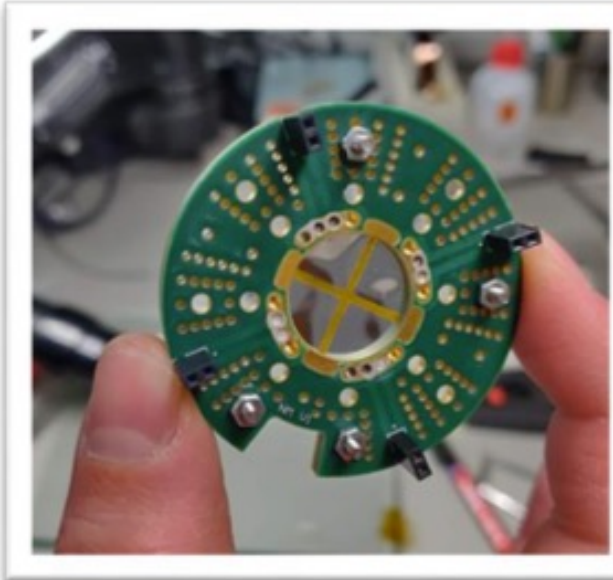
24 GeV/c, 400 msec, $5e11$ p/spills, 12×12 mm² FWHM

cern.cn/ps-irrad



Ultra Thin Beam Position Monitors

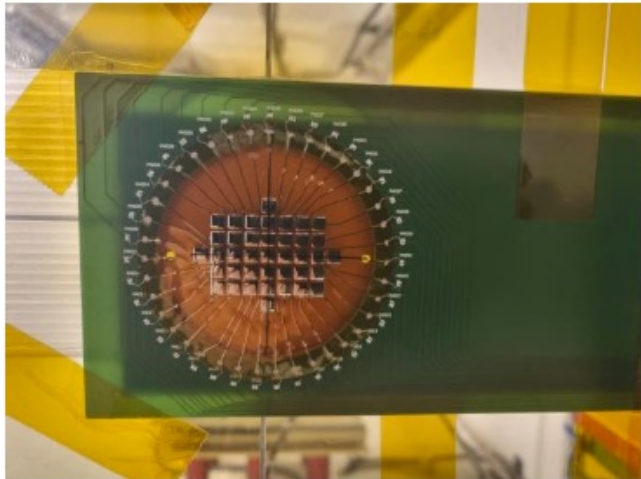
Support the development of **nano-BPM** for AD **Al/Parylene (10/100nm)** for keV range



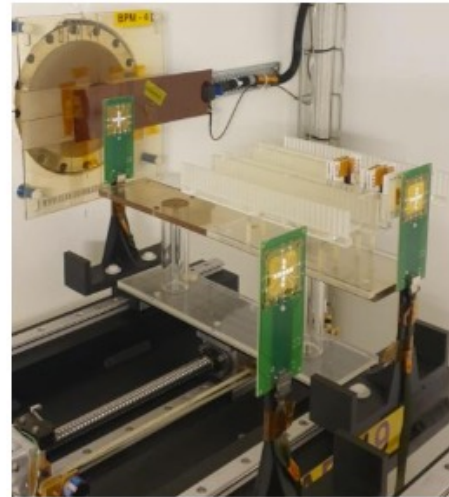
IRRAD Beam Profile Monitors

Innovative Beam Profile Monitors:

- new **mini-BPM** Al/Kapton ($0.3/25\mu\text{m}$) produced, tested in IRRAD, now operational
- large pattern **micro-BPM** Al/Kapton ($0.2/25\mu\text{m}$): first prototype tested, new production ongoing



40channel micro-BPM device



New mini-BPMs

